

Vancouver, BC, Canada - March 2017

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Abbott, Justin	Lumentum	Lumentum		1	1	1	3
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Agnes, Andrea	STMicroelectronics	STMicroelectronics	1	1	1	1	4
Amason, Dale	NXP Semiconductors	NXP Semiconductors		1	1	1	3
Angha, Ali	Spirent Communications	Spirent Communications	1	1	1	1	4
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	4
Baden, Eric	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Baldwin, Thananya	Ixia	Ixia	1	1	1		3
Bar-Niv, Amir	Aquantia Corp	Aquantia		1			1
Beaudoin, Denis	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Beia, Christian	STMicroelectronics	STMicroelectronics	1	1	1	1	4
Belitz, Tobias	Renesas Electronics Corporation	Renesas Electronics Corporation		1	1	1	3
Bohm, Mark	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Bouda, Martin	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1	1	1	4
Brandt, David	Rockwell Automation	Rockwell Automation	1	1	1	1	4
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	4
Brillhart, Theodore	Fluke Corporation	Fluke Corporation		1	1	1	3
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1	4
Brown, Alan M	ADTRAN Inc.	ADTRAN Inc.	1	1	1	1	4
Brown, Matthew	Applied Micro (AMCC)	Applied Micro (AMCC)		1	1		2
Brownlee, Phillip	TDK Corporation	TDK Corporation	1	1	1	1	4
Bullock, Chris	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Bustos Heredia, Jairo	Würth Elektronik Group	Würth Elektronik Group	1	1	1	1	4
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES		1	1	1	3
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1	4
Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Chabot, Craig	University of New Hampshire InterOperability	University of New Hampshire InterOperability	1	1	1		3
Chadha, Mandeep	Microsemi Corporation	Microsemi Corporation	1	1	1		3
Chalupsky, David	Intel Corporation	Intel Corporation		1	1	1	3
Chang, Jacky	Hewlett Packard Enterprise	Hewlett-Packard Development Company		1	1	1	3
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4

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Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1	1	4
Chen, Jay	maxlinear	Maxlinear	1	1	1	1	4
Chen, Li-Chung	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1	1	4
Cheng, Weiying	Coriant	Coriant				1	1
Choudhury, Golam	OFS	OFS	1	1	1	1	4
Chuang, Keng Hua	Hewlett Packard Enterprise	Hewlett-Packard Development Company	1	1	1	1	4
Cober, Donald	CoMira Solutions, Inc.	CoMira Solutions, Inc.	1	1	1	1	4
Coenen, Robert	Advantage Optics	Advantage Optics	1	1			2
Coenen, Robert	Reflex Photonics	Self Employed	1				1
Cole, Christopher R	Finisar Corporation	Finisar Corporation	1	1	1		3
Colella, Barry	Source Photonics	Source Photonics		1	1		2
Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.		1	1		2
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1	1	1	4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation	1		1	1	3
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Dawson, Fred	Chemours Canada Company	Chemours Canada Company	1	1	1	1	4
DiBiaso, Eric	TE Connectivity	TE Connectivity	1	1	1	1	4
Diminico, Christopher	M C Communications, LLC	Panduit Corp.	1	1	1		3
Djahanshahi, Hormoz	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Donahue, Curtis	University of New Hampshire InterOperat	UNH-IOL	1	1	1	1	4
Dudek, Michael	Cavium	Cavium	1	1	1	1	4
Dupuis, Marc	Web Industries	Web Industries		1	1		2
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Eiriksson, Asgeir	Chelsio Communications	Chelsio Communications				1	1
Eitel, Cornelia	Hirschmann Automation and Control, Inc	Hirschmann Automation and Control, Inc	1	1	1	1	4
Ellison, Jason		The Siemon Company	1	1	1		3
Emmendorfer, Michael	ARRIS Group	ARRIS Group		1	1		2
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1	4
Ewen, John	GLOBALFOUNDIRES	GLOBALFOUNDIRES	1	1	1		3
Feldman, Shahar	Microsemi Corporation	Microsemi Corporation		1	1	1	3
Fife, James	eTopus Technology, Inc.	eTopus Technology, Inc.	1	1	1		3
Flatman, Alan	LAN Technologies Corporation, Inc.	LAN Technologies Corporation, Inc.	1	1	1	1	4

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Franchuk, Brian	Emerson Process Management	Emerson Process Management	1	1	1	1	4
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	4
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1	1	1	3
Gardner, Mike	Molex Incorporated	Molex Incorporated		1	1	1	3
Gauthier, Claude	OmniPhy	OmniPhy		1	1	1	3
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD	1	1	1	1	4
Gilb, James	General Atomics Aeronautical Systems, I	Self		1	1		2
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.	1	1	1	1	4
Gorshe, Steven Scott	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Gottron, Jens	Siemens AG	Siemens AG	1	1	1		3
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH	1	1	1	1	4
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH	1	1	1	1	4
Grow, Robert	RMG Consulting	RMG Consulting	1	1	1		3
Guckenberger, John	Luxtera	Luxtera	1	1	1		3
GUO, YONG	ZTE Corporation	ZTE Corporation	1	1	1		3
Gustlin, Mark	Xilinx	Xilinx	1	1	1	1	4
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1	4
Harstead, Ed	Nokia	Nokia		1	1		2
Hashimoto, Tomohiro	socionext	socionext	1	1	1	1	4
Hayakawa, Akinori	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	4
Hayashi, Takehiro	HAT Lab., Inc.	HAT Lab., Inc.		1	1	1	3
Healey, Adam	Broadcom Ltd.	Broadcom Ltd.	1	1	1	1	4
Hegde, Rajmohan	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Hess, David	CORD DATA	CORD DATA		1	1	1	3
Hidaka, Yasuo	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1	1	1	4
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.		1	1	1	3
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact	1	1	1		3
HUANG, Xi	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1		2
Huang, Xingang	ZTE Corporation	ZTE Corporation	1	1	1	1	4
HYAKUTAKE, YASUHIRO	Adamant Co., Ltd.	Adamant Co., Ltd.	1	1	1	1	4
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology		1	1	1	3
ISHIBE, KAZUHIKO	Anritsu Company	Anritsu Company	1	1	1	1	4

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Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1		3
Jackson, Kenneth	Sumitomo Electric Device Innovations, U	Sumitomo Electric Industries, LTD	1	1	1	1	4
Jimenez, Andrew	Anixter Inc.	Anixter Inc.	1	1	1		3
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kawatsu, Yasuaki	APRESIA Systems	Hitachi Metals, Ltd.	1	1	1	1	4
Kim, Yongbum	Broadcom LTD	Broadcom Corporation		1	1	1	3
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1	1	4
King, Jonathan	Finisar Corporation	Finisar Corporation		1	1		2
Knittle, Curtis	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable	1	1	1	1	4
Kolesar, Paul	CommScope	CommScope, Inc.	1	1	1		3
Kramer, Glen	Broadcom Corporation	Broadcom Corporation	1	1		1	3
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in Communications - G	1	1	1	1	4
Lapak, Jeffrey	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Laubach, Mark	Broadcom Limited	Broadcom Corporation	1	1	1	1	4
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies		1	1		2
Lee, Han Hyub	ETRI	ETRI	1	1	1		3
Lee, June Hee	SAMSUNG ELECTRONICS	SAMSUNG ELECTRONICS		1	1	1	3
Leizerovich, Hanan	Multiply	Multiply	1	1	1	1	4
Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1	4
Lewis, Jon	Dell	Dell	1	1	1	1	4
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Lingle, Robert	OFS	OFS	1	1	1		3
liu, dekun	Huawei Technologies Co., Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1	1	4
LIU, XIANG	Huawei R&D USA	Huawei				1	1
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	4
Madgar, Zahy	Valens Semiconductor	Valens Semiconductor	1	1	1	1	4
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1		1	3
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4

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Malicoat, David	Malicoat Networking Solutions	Kazan Networks	1	1	1	1	4
Matheus, Kirsten	BMW Group	BMW Group	1	1	1	1	4
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation		1	1	1	3
McCarthy, Mick	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1	4
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
McDonough, John	NEC Corporation	NEC America		1	1	1	3
McMillan, Larry	Western Digital Corporation	Western Digital Corporation	1	1	1	1	4
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation			1	1	2
Medina, Marcel	Spirent Communications	Spirent Communications	1	1	1	1	4
Mei, Richard	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	1	1		3
Migueluez, Phil	Comcast	Comcast		1	1	1	3
Moffitt, Bryan	CommScope	CommScope, Inc.	1	1	1	1	4
Mueller, Harald	Endress + Hauser	Endress + Hauser	1	1	1		3
Muyshondt, Henry	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1		3
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Noll, Kevin	TiBIT Communications	Tibit Communications		1	1		2
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1	1	1		3
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Palkert, Thomas	EIC	Molex-MoSys	1	1		1	3
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
Patel, Harsh	Molex LLC	Molex LLC	1	1	1	1	4
Peker, Arkadiy	Microsemi Corporation	Microsemi Corporation		1	1	1	3
peng, wanquan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Pepper, Gerald	Ixia	Ixia	1	1	1		3
Peters, Michael	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	1	1	1	1	4
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1	4
Picard, Jean	Texas Instruments Incorporated	Texas Instruments Incorporated		1	1	1	3
Piehler, David	Dell	Dell	1	1	1	1	4
Pimpinella, Rick	Panduit Corp.	Panduit Corp.	1	1	1		3
Poelstra, Henry	Teledyne Lecroy	Teledyne Lecroy	1	1	1		3

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Powell, William	Nokia	Nokia		1	1	1	3
Pozzebon, Dino	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Rabinovich, Rick	Ixia	Ixia	1	1	1	1	4
RAN, ADEE	Intel Corporation	Intel Corporation	1	1	1	1	4
Regev, Alon	Ixia	Ixia	1	1	1	1	4
Rerein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1	4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1	1	4
Ressler, Michael	Hitachi Cable America Inc.	Hitachi Cable America Inc.	1	1	1	1	4
Rotolo, Salvatore	STMicroelectronics	STMicroelectronics	1	1	1	1	4
Sambasivan, Sam	AT&T	AT&T	1	1	1	1	4
Sayre, Edward	Teraspeed Consulting, a division of Samt	Teraspeed, a division of Samtec	1	1	1	1	4
Schindler, Fred	Seen Simply	Seen Simply	1	1	1	1	4
Schweitz, Laura	Turck Inc.	Turck Inc.	1	1	1		3
Sedarat, Hossein	Aquantia	Aquantia		1	1		2
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Shirao, Mizuki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation		1	1	1	3
Shrikhande, Kapil	Innovium Inc.	Innovium	1	1	1		3
Slavick, Jeff	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Sleigh, Robert	Keysight Technologies	Keysight Technologies		1	1		2
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC		1	1	1	3
Sommers, Scott	Molex Incorporated	Molex Incorporated		1	1	1	3
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1	4
Srivastava, Atul	NEL-America	NTT Electronics	1		1		2
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Stauffer, David	Kandou Bus	Kandou Bus, S.A.	1	1	1		3
Stewart, Heath	Linear Technology	Linear Technology	1		1	1	3
Stover, David	Linear Technology	Linear Technology	1	1	1	1	4
Sun, Junqing	Credo Semiconductor	Credo Semiconductor	1	1	1	1	4
Suzuki, Ken-Ichi	Nippon Telegraph and Telephone Corp	NTT	1	1	1		3
Suzuki, Naoki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation		1			1
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Szczepanek, Andre	Inphi Corporation	Inphi Corporation	1	1	1	1	4

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TAKAHARA, TOMOO	Fujitsu Optical Components Limited	FUJITSU LABORATORIES LIMITED		1	1	1	3
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.		1	1	1	3
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1	4
Tellas, Ronald	Belden	Belden	1	1	1	1	4
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1	1	1	4
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	4
Tremblay, David	Hewlett Packard Enterprise	Hewlett-Packard Company		1	1	1	3
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1	4
Uchiyama, Asami	Mitsubishi Electric US, Inc.	Mitsubishi Electric Corporation	1	1	1		3
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1	4
Umeda, Daisuke	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD		1	1	1	3
Umnov, Alexander	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Vaden, Sterling	Vaden Enterprises	Vaden Enterprises	1	1	1	1	4
Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC	1	1	1	1	4
Van Veen, Dora	Nokia	Nokia		1			1
Walker, Dylan	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Walter, Edward	AT&T	AT&T		1	1	1	3
Wang, Roy	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Wang, Tongtong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1				1
Wendt, Matthias	Philips Lighting	Philips Lighting	1	1	1		3
Wertheim, Oded	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Wey, Jun Shan	ZTE Corporation	ZTE Corporation	1	1	1	1	4
white, martin	Cavium	Cavium		1	1		2
Wienckowski, Natalie	General Motors Company	General Motors Company	1	1	1	1	4
Winkel, Ludwig	Siemens AG	Siemens AG	1	1	1	1	4
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Wu, Xin	Genesis Connected Solutions	Molex Incorporated	1	1			2
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser	1	1	1		3
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Yasueda, Jim	Teledyne Lecroy	Teledyne Lecroy	1	1			2
YI, JUN	Champlain cable corporation	Champlain cable corporation	1	1	1		3

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Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1	4
Yseboodt, Lennart	Philips Electronics	Philips Electronics	1	1	1	1	4
ZHANG, DEZHI	China Telecommunications Corporation	China Telecommunications Corporation	1	1	1	1	4
Zhang, Huanlin	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc	1	1	1		3
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Zielinski, Martin	Emerson Electric Co.	Emerson Process Management	1	1	1	1	4
Zimmerman, George	CME Consulting	ADI, Aquantia, CommScope, Inc., Linear		1	1	1	3
Zinner, Helge	Continental Automotive Systems AG	Continental Automotive Systems AG	1	1	1	1	4
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1	4